E lectronic Transport through Y B a_2 C u_3 O $_7$ G rain B oundary Interfaces between 4.2 K and 300 K

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Abstract

The current-induced dissipation in YBa₂Cu₃O₇ grain boundary tunnel junctions has been measured between 4.2K and 300K. It is found that the resistance of 45 (100)/(110) junctions decreases linearly by a factor of four when their temperature is increased from 100K to 300K. At the superconducting transition temperature T_c the grain boundary resistance of the norm al state and of the superconducting state extrapolate to the sam e value. 74.20 Rp, 74.50.+ r, 74.76 Bz, 85.25 Cp

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Soon after the discovery of superconductivity in $La_2 \times Ba_x CuO_4$ [1] it was realized that the norm al-state properties of the high-T_c cuprates di er signi cantly from those of the low – T_c superconductors. The most prominent and still unexplained norm all state properties of the high-T_c compounds are the linear temperature dependence of the in-plane resistivity in the optim ally doped compounds [2], spin and charge inhom ogeneities [3], and the pseudogap present in the underdoped regim e [4].

The complex electronic behavior of the high- T_c materials is also rejected in the characteristics of their interfaces. For $T < T_c$, for example, large-angle grain boundaries are excellent tunnelling barriers [5], a feature unknown from conventional superconductors. Severalm echanisms responsible for the electronic transport properties of grain boundaries and other interfaces have been identified for the temperature range below T_c , such as the d_{x^2/y^2} dom inated order parameter symmetry, structural elects and space charge layers [5]. In fact, grain boundaries operated below T_c have been used to reveal fundaminate properties of the high- T_c cuprates, such as the existence of C coper pairs [6] or the unconventional order parameter symmetry [7].

A s is the case for $T < T_c$, we expect valuable inform ation on the interfaces of the cuprates, or even on the bulk materials them selves, to be contained in the tunneling characteristics of grain boundaries for $T > T_c$. However, only very few data are available for this tem perature regime [5,8]. This lack of data arises from the di culty to measure the grain boundary current-voltage (I (V_{gb})) characteristics free of voltages produced by the bridges that are needed to contact the interfaces. By utilizing a di erence-technique to subtract these unwanted voltages, we have now succeeded in measuring the current-voltage characteristics of YBa₂Cu₃O₇ grain boundaries for 42 K T 300 K. These studies provide evidence that the norm all state resistance of 45 (100)/(110) tilt grain boundaries is not in uenced by the onset of the superconducting transition. The experiments furtherm ore reveal that for $T > T_c$

The experiments were performed with bicrystalline YB a_2 C u_3 O₇ In s grown by pulsed laser deposition at 760 C in 0.25 m bar of O₂ to a typical thickness of 40 (50 nm . The SrT iO₃-

substrates contained sym m etric and (100)/(110)-asym m etric 45 [001]-tilt grain boundaries, speci ed to within 1 . A fler deposition, the sam ples were cooled during two hours in an O₂-pressure of 400m bar. Because the deposition geom etry was tuned to optim ize the hom ogeneity of the sam ples, T_c varied by less than 0.5K across the wafers, while the thickness variations were smaller than 10%. For the four-point m easurements, gold contacts were structured photolithographically before the YBa₂Cu₃O₇ In swere patterned by etching in a H₃PO₄ solution, or by dry etching with an Ar ion-beam. The YBa₂Cu₃O₇ bridges had widths and lengths between the voltage probes of 2.5 m and 30 m, respectively (see Fig. 1), and their T_c varied less than 200m K. In addition, several sam ples were patterned into W heatstone-bridge con gurations, of which each arm consists of a m eander line containing 23 straight sections with widths of 6 m. Two of the meander lines were patterned such that each of the 23 sections crosses the boundary once.

The technique to measure precisely the grain boundary resistance R_{gb} below T_c is based on measuring the I (V_{gb}) characteristics of the Josephson junctions while applying a microwave eld large enough to suppress their critical current. For this purpose, we used low frequency microwaves (< 10 G H z) to avoid inaccuracies resulting from the Shapiro steps.

A llm easurem ents were conducted in shielded room s using m otor-driven dip-sticks. The sam ples were cooled at 4.2 K in liquid H elium, at 77 K in liquid nitrogen, and at other tem peratures via He oder N_2 vapor and therm al conduction across the sam ple holder. Im – m ersion into the cooling liquids did not a ect the characteristics, providing evidence that self-heating is insigni cant under the experim ental conditions.

For $T > T_c$ the transport properties of the interfaces cannot be measured with a straightforward four-point technique because the voltage $V_{m eas}$ generated by a bridge straddling the boundary is composed of two contributions: a) the grain boundary voltage V_{gb} and b) the voltages V_{g1} and V_{g2} caused by the resistive grains inside the bridge. This problem can be solved by subtracting from $V_{m eas}$ the grain contributions V_{g1} and V_{g2} . For this, V_{g1} and V_{g2} are obtained by approximating them with the voltages V_{g1}^2 and V_{g2}^2 generated by independent intragrain bridges that are measured simultaneously. Not surprisingly, test measurements revealed variations of $V_{g1}^{?}$ and $V_{g2}^{?}$ of several percent as a function of the bridge location. Therefore, the intragrain bridges were placed as closely as possible to the boundary bridge (see Fig. 1). The desired measurement accuracy also determined the optimum size of the bridges. On the one hand the bridges were patterned to be as small as possible so that they could be located close to the grain boundary. On the other hand, their size was chosen to be large enough for the patterning-induced scatter of the bridge aspect ratios to be insignificant. In samples optimized this way, the voltages across the two bridges $V_{g1}^{?}$ and $V_{g2}^{?}$ were identical to within 1% at 100K and to 0.3% for T > 200K. Therefore the grain boundary voltage equals with the sam e accuracy V_{gb} V_{meas} ($V_{g1}^{?} + V_{g2}^{?}$)=2.

A s introduced by M athur et al. [9] for studies of La_{1 x} C a_xM nO₃ bicrystals, and similar to the work described in R ef. [8], we also patterned several sam ples into W heatstone-bridges. This approach has the advantage that the generated voltages are huge and that $V_{g1}^{?}$ and $V_{g2}^{?}$ are subtracted from $V_{m eas}$ already during the m easurem ent. H aving perform ed m easurem ents with such bridges, we checked their balance by photolithographically cutting the W heatstone-con gurations, to individually assess the resistances of the m eander lines. Because these studies revealed T dependent balancing errors of 1{10%, we preferred the three-bridge approach for m easurem ents of the R_{gb} (T)) characteristics, while W heatstonebridges were chosen when a large signal was required, as was the case for som e studies of I (V) characteristics.

To gain insight into the electronic transport mechanisms, we measured the I (V) characteristics between 4.2K and 300 K by using W heatstone-bridges. For $T > T_c$ the characteristics are non-linear on this large voltage scale, in particular below 150K (see Fig. 2). A nalyzing the non-linearity, we rst note that the microstructure of the grain boundaries is inhom ogeneous down to the unit cell level [5]. The I (V) curves are therefore generated by large numbers of microstructurally di erent channels connected in parallel. The behavior of the averaged junctions is consistent with the one of a back-to-back Schottky contact as predicted by the band bending model [10]. If tentatively described by a Simmons-t [11], the averaged I (V) characteristics correspond to heights and widths of hypothetical e ective junction barriers of 100 m eV and 1{2 nm. Thus, these data suggest unusually small barrier heights. They are, in particular, much smaller than the energy scale of grain boundary built-in potentials measured by electron-holography of 2 eV [12].

At small voltages, $V_{gb} < 10 \text{ mV}$, the non-linearity of the I(V) curves is insigni cant, and they are characterized by their ohm ic resistance, which can be obtained by selecting an appropriate voltage (V_{cr}) or current (I_{cr}) criterion $V_{cr} = I_{cr}$ R_{gb} < 10 mV. For T < T_c, due to the m icrowave irradiation, the I(V) characteristics are linear, too, even over a larger voltage range. The only exception is given by 45 boundaries at T < 40 K, which will be discussed below. Applying the three-bridge technique, we were therefore able to deduce the R_{gb} (T) dependence of a given grain boundary by m easuring in one tem perature sweep from 42K to 300K just one boundary bridge plus the two intragrain reference bridges. Hereby one voltage or current criterion, typically $I_{cr} = 100$ A, is used for all tem peratures.

The R (T)-dependence of a 45 symmetric grain boundary measured this way is presented in Fig.3. The resistance-area product $R_{ab}A$ (77 K) 1 10 ⁸ cm ² com pares well with literature values [5]. Three rem arkable features are displayed by the tem perature dependence of the resistance. First, the resistance reaches a maximum at 30K (see also Fig. 4). This maximum is not displayed by symmetric 24 and 36 boundaries measured as reference sam ples. Second, around T_c the resistance develops a distinct peak structure. This peak, which is not associated with the microwave irradiation, was found to vary from sample to sample, and to change with time over weeks. Except for this peak, the grain boundary resistance of the norm al state and of the superconducting state extrapolate within the measurem ent accuracy of 2% to the same value R_{gb} (T_c) = 10.7 . This tem perature dependence is characteristic for all samples we have studied, except for few that displayed at T_c a resistance step of < 5%. As this step was found to be not reproducible and to increase for a given sample over weeks, we consider it to be an artifact resulting from them ical reactions or di usion. Third, between 100K and 300K the resistance decreases with increasing tem perature by a factor of four. The tem perature dependence is hereby rem arkably linear, with a barely noticeable positive curvature (Fig. 3, upper inset). This is in striking contrast to

the linear resistance increase of the adjacent $Y B a_2 C u_3 O_7$ grains (Fig. 3, lower inset). In the following, we will discuss the three features and their in plications for the understanding of the interfaces, beginning with the superconducting regime.

At low temperatures, the resistance of 45 grain boundaries changes non-m onotonically with T, and even depends on the value of the tunneling current (see Fig. 4). This maximum and its current bias dependence are consistent with the form ation of a zero-bias anom aly by the faceted 45 junctions. At sm all bias currents V_{gb} is of the order 1 m V, and therefore sufciently sm all to probe the temperature dependent shape of the zero-bias conductance peak in the superconducting energy gap. This zero-bias conductance peak is usually presum ed to arise from Andreev bound states generated by the $d_{x^2 y^2}$ order parameter symmetry of YBa₂Cu₃O₇ [13].

The peak structure at 89 K provides evidence that at T_c the resistance of the grain boundary bridge is much larger than the resistance of the intragrain-bridges. The observed height of the peak shown in Fig. 3 is consistent with a T_c di erence of the bridges of 150 m K. The shape of the peak is in uenced by the di erences in the uctuations of the intragrain bridges and the one containing the tunnel junction. Unfortunately we cannot extract data on this e ect from the peak, as the spatial distribution of T_c is unknown.

The grain boundary resistance values above and below T_c extrapolate to the same value at the transition temperature. The transition into the superconducting state is therefore found not to a ect the dissipation in the junctions at T_c . This observation cannot be reconciled with the predictions for surface charging e ects in the hole superconductivity scenario introduced by H irsch and coworkers [14]. In this scenario, charges are separated in the superconducting state in the vicinity of a grain boundary, but not above T_c . This charge separation is expected to change the electronic properties of the interfaces when passing through T_c [15]. The grain boundary data do not show this e ect.

For $T > T_c$, the grain boundary resistance decreases linearly. This behavior cannot be explained by elastic tunneling from the vicinity of a well-de ned Ferm i surface across standard Schottky contacts with T-independent barrier heights and widths [16]. There, a nonlinear and weak R_{gb} (T) characteristic is expected for the parameter range derived above. A more detailed elastic tunneling model has to include T dependent Schottky barriers and to consider the spatial inhomogeneity of the interface. To significantly alter the weak and nonlinear T dependence both elects dem and the thermal energy k_B T to exceed the energy scales of the barrier for large parts of the interface areas. Hereby a very special energy proble of the barriers is required to yield the linear R_{gb} (T) behavior over a large temperature range. This situation seem sunphysical to us. We note that inelastic tunneling via resonant in purity channels [17] cannot account for the linear temperature characteristic either. Considering the problem swhich standard sem iconductor models have in describing the observed interface characteristics, we now turn our attention to the elect of the electronic correlations present in the cuprates.

As pointed out by M iller and Freericks [18] electronic correlations strongly a ect the barrier properties of high-T_c interfaces in the superconducting state. This is also true in the norm al conducting state. As suggested by the band bending model [10], the barrier is an underdoped region, with the possible form ation of antiferrom agnetic uctuations or even of local magnetic moments. The resultant magnetic scattering is expected to increase the interface resistance with decreasing tem perature. Since the density of the magnetic moments is not known, the R_{ab} (T) dependence cannot be determined yet. Besides correlations in the barrier, electronic correlations in the bulk may also in uence the transport through the interface. W hat would be expected if, due to the grain boundary charging, the YB a_2 C u_3 O $_7$ layers ad poent to the grain boundary were underdoped, characterized by a pseudo gap and, possibly, by preform ed pairs? The spectral densities of the electronic excitations on both sides of the interface control the tunneling process. It is only for the 45 grain boundaries under consideration, that the nodal and antinodal directions of the pseudogap are directly coupled, and the tunneling current is most strongly reduced. As the pseudo gap diminishes for increasing temperature, the boundary conductivity is expected to increase. Here we note that the R_{ab} (T) curve is characterized by one tem perature scale, T_0 , the extrapolated zero-resistance intercept. In the sam ples investigated, T_0 ' 350 K, which corresponds to the

pseudo gap energy scale.

In sum m ary, it is found that the resistance of 45 [001]-tilt Y B a₂C u₃O₇ grain boundary junctions decreases linearly with increasing temperature for $T > T_c$. In the vicinity of T_c the grain boundary resistance and thus the dissipation are indistinguishable for $T < T_c$ and $T > T_c$, in contradiction to predictions of the theory of hole superconductivity. The I (V) characteristics between 4.2 K and 300 K are nonlinear, suggesting a tunneling barrier with an elective height and width of 0.1 eV and 1{2 nm, respectively. The linear R_{gb} (T) dependence is proposed to be caused by correlation controlled tunneling.

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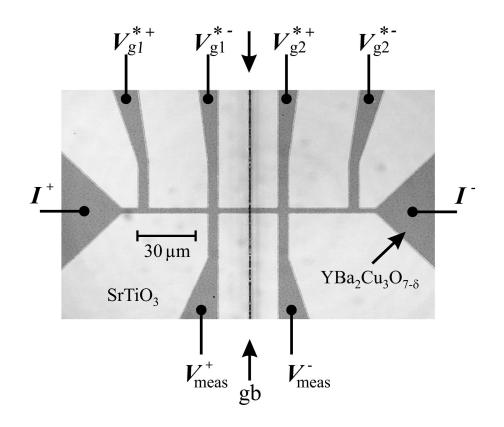
FIGURES

FIG.1. Optical m icrograph of a three-bridge sample used to measure R_{gb} . The 45 grain boundary (gb) is indicated by the arrow s.

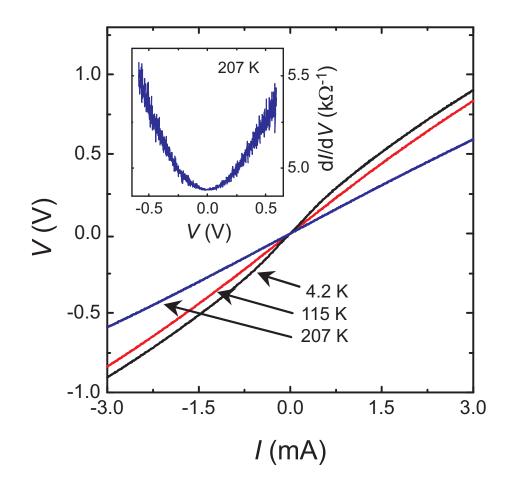
FIG.2. Current-voltage characteristics of a W heatstone-bridge containing 23 junctions with a 45 asymmetric boundary in a 50 nm thick $YBa_2Cu_3O_7$ lm. The voltage V corresponds to the voltage across all junctions, V = 23 V_{gb} , the current I is twice the current owing through one m eander line.

FIG.3. M easured tem perature dependence of the resistance of a 45 sym m etric grain boundary in a 40 nm thick YBa₂Cu₃O₇ lm ($I_{cr} = 100$ A). The peak reaches a maximum of 25 at 88.3K. The insets show dR/dT (T) for the grain boundary and the corresponding R (T) curve of one grain located next to the boundary.

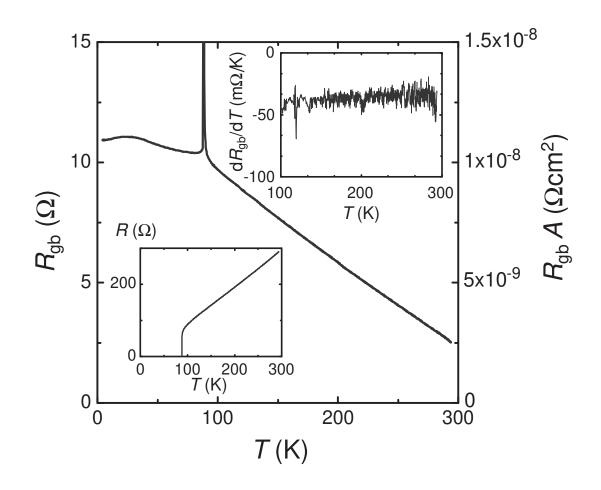
FIG.4. Temperature dependence of the resistance of a 45 symmetric grain boundary in a 40 nm thick YBa₂Cu₃O₇ Immeasured in the three-bridge conguration. The inset shows the temperature dependent resistance of a 45 asymmetric grain boundary in a 50 nm thick Immeasured in a W heatstone-bridge conguration.



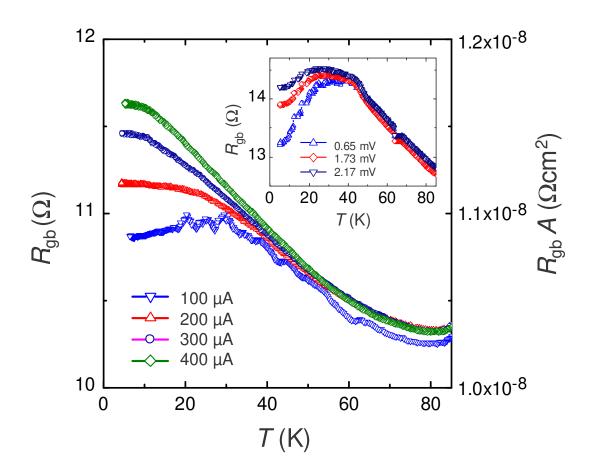
Schneider et al., Figure 1



Schneider et al., Figure 2



Schneider et al., Figure 3



Schneider et al., Figure 4